



Vincotech

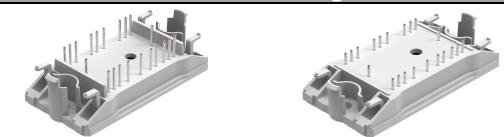
V23990-P868-F49-PM

V23990-P868-F48-PM

datasheet

**flow PACK 0****1200 V / 15 A****Features**

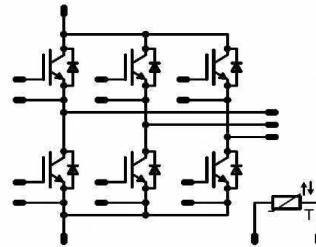
- 2 clip housing in 12 mm and 17 mm height
- Trench Fieldstop IGBT<sup>4</sup> technology
- Compact and low inductance design
- Built-in NTC

**flow 0 housing****Target Applications**

- Motor Drives
- Power Generation
- UPS

**Types**

- V23990-P868-F49-PM
- V23990-P868-F48-PM

**Schematic****Maximum Ratings** $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                         | Symbol               | Condition  | Value     | Unit               |
|-----------------------------------|----------------------|--|-----------|--------------------|
| <b>Inverter Transistor</b>        |                      |  |           |                    |
| Collector-emitter voltage         | $V_{CE}$             |  | 1200      | V                  |
| DC collector current              | $I_C$                |  | 15        | A                  |
| Repetitive peak collector current | $I_{CRM}$            | $t_p$ limited by $T_{jmax}$                            | 45        | A                  |
| Power dissipation                 | $P_{tot}$            | $T_j = T_{jmax}$                                       | 64        | W                  |
| Gate-emitter peak voltage         | $V_{GE}$             |  | $\pm 20$  | V                  |
| Short circuit ratings*            | $t_{SC}$<br>$V_{CC}$ | $T_j \leq 150^\circ\text{C}$<br>$V_{GE} = 15\text{ V}$ | 10<br>800 | $\mu\text{s}$<br>V |
| Maximum Junction Temperature      | $T_{jmax}$           |  | 175       | $^\circ\text{C}$   |

\* It is recommended to not exceed 1000 short circuit situations in the lifetime of the module and to allow at least 1s between short circuits

**Inverter Diode**

|                                 |            |                             |      |                  |
|---------------------------------|------------|-----------------------------|------|------------------|
| Peak Repetitive Reverse Voltage | $V_{RRM}$  |                             | 1200 | V                |
| DC forward current              | $I_F$      |                             | 15   | A                |
| Repetitive peak forward current | $I_{FRM}$  | $t_p$ limited by $T_{jmax}$ | 30   | A                |
| Power dissipation               | $P_{tot}$  | $T_j = T_{jmax}$            | 45   | W                |
| Maximum Junction Temperature    | $T_{jmax}$ |                             | 175  | $^\circ\text{C}$ |

**Thermal properties**

|                                |           |  |                          |                  |
|--------------------------------|-----------|--|--------------------------|------------------|
| Storage temperature            | $T_{stg}$ |  | -40.....+125             | $^\circ\text{C}$ |
| Operation junction temperature | $T_{op}$  |  | -40.....+ $T_{jmax}$ -25 | $^\circ\text{C}$ |



Vincotech

**V23990-P868-F49-PM****V23990-P868-F48-PM**

datasheet

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                    | Symbol            | Condition                            | Value    | Unit |
|------------------------------|-------------------|--------------------------------------|----------|------|
| <b>Insulation properties</b> |                   |                                      |          |      |
| Insulation voltage           | $V_{\text{isol}}$ | DC Test Voltage* $t_p = 2 \text{ s}$ | 6000     | V    |
|                              |                   | AC Voltage $t_p = 1 \text{ min}$     | 2500     | V    |
| Creepage distance            |                   |                                      | min.12,7 | mm   |
| Clearance                    |                   | 12mm height                          | 9,22     | mm   |
|                              |                   | 17mm height                          | min.12,7 | mm   |
| Comparative Tracking Index   | CTI               |                                      | >200     |      |

\*100% tested in production

**Characteristic Values**

| Parameter | Symbol | Conditions   |           |           |            |              |              | Value     |           |     | Unit |
|-----------|--------|--------------|-----------|-----------|------------|--------------|--------------|-----------|-----------|-----|------|
|           |        | $V_{GE}$ [V] | $V_r$ [V] | $I_c$ [A] | $T_i$ [°C] | $V_{GS}$ [V] | $V_{CE}$ [V] | $I_t$ [A] | $I_D$ [A] | Min |      |

**Inverter Transistor**

|   |               |   |          |      |        |           |     |              |              |     |     |
|---|---------------|---|----------|------|--------|-----------|-----|--------------|--------------|-----|-----|
| Gate emitter threshold voltage                | $V_{GE(th)}$  | $V_{CE} = V_{GE}$                               |          |      | 0,0005 | 25        |     | 5            | 5,8          | 6,5 | V   |
| Collector-emitter saturation voltage          | $V_{CESat}$   |   | 15       |      | 15     | 25<br>150 |     |              | 1,84<br>2,23 | 2,3 | V   |
| Collector-emitter cut-off current incl. Diode | $I_{CES}$     |   | 0        | 1200 |        | 25        |     |              |              | 5   | μA  |
| Gate-emitter leakage current                  | $I_{GES}$     |   | 20       | 0    |        | 25        |     |              |              | 200 | nA  |
| Integrated Gate resistor                      | $R_{gint}$    |   |          |      |        |           |     |              | none         |     | Ω   |
| Turn-on delay time                            | $t_{d(on)}$   | $R_{gon} = 32 \Omega$<br>$R_{goff} = 32 \Omega$ | $\pm 15$ | 600  | 15     | 25<br>150 |     | 86<br>84     |              |     | ns  |
| Rise time                                     | $t_r$         |   |          |      |        | 25<br>150 |     | 17,8<br>23,6 |              |     |     |
| Turn-off delay time                           | $t_{d(off)}$  |   |          |      |        | 25<br>150 |     | 201<br>264   |              |     |     |
| Fall time                                     | $t_f$         |   |          |      |        | 25<br>150 |     | 81<br>130    |              |     |     |
| Turn-on energy loss per pulse                 | $E_{on}$      |   |          |      |        | 25<br>150 |     | 0,95<br>1,40 |              |     | mWs |
| Turn-off energy loss per pulse                | $E_{off}$     |   |          |      |        | 25<br>150 |     | 0,83<br>1,37 |              |     |     |
| Input capacitance                             | $C_{ies}$     |   |          |      |        |           |     | 900          |              |     |     |
| Output capacitance                            | $C_{oss}$     |   |          |      |        |           | 25  | 80           |              |     | pF  |
| Reverse transfer capacitance                  | $C_{rss}$     | $f = 1 \text{ MHz}$                             | $0$      | 25   | 15     |           |     | 55           |              |     |     |
| Gate charge                                   | $Q_G$         |   |          |      |        | 15        | 960 | 25           |              | 93  | nC  |
| Thermal resistance chip to heatsink           | $R_{th(j-s)}$ |   |          |      |        |           |     |              | 1,47         |     | K/W |

**Inverter Diode**

|                                       |                      |                       |          |     |    |           |  |              |      |      |
|---------------------------------------|----------------------|-----------------------|----------|-----|----|-----------|--|--------------|------|------|
| Diode forward voltage                 | $V_F$                |                       |          |     | 15 | 25<br>150 |  | 1,84<br>1,77 | 2,4  | V    |
| Peak reverse recovery current         | $I_{RRM}$            | $R_{gon} = 32 \Omega$ | $\pm 15$ | 600 | 15 | 25<br>150 |  | 14,8<br>16,2 |      | A    |
| Reverse recovery time                 | $t_{rr}$             |                       |          |     |    | 25<br>150 |  | 289<br>447   |      | ns   |
| Reverse recovered charge              | $Q_{rr}$             |                       |          |     |    | 25<br>150 |  | 1,54<br>2,68 |      | μC   |
| Peak rate of fall of recovery current | $(di_{rf}/dt)_{max}$ |                       |          |     |    | 25<br>150 |  | 92<br>59     |      | A/ms |
| Reverse recovered energy              | $E_{rec}$            |                       |          |     |    | 150       |  | 1,08         |      | mWs  |
| Thermal resistance chip to heatsink   | $R_{th(j-s)}$        |                       |          |     |    |           |  |              | 2,13 |      |

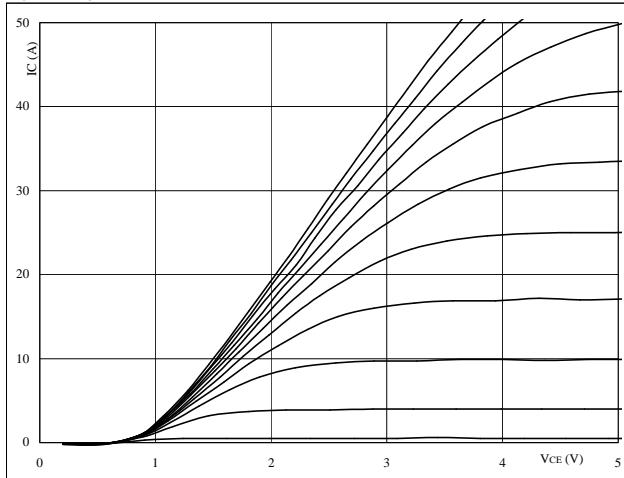
**Thermistor**

|                            |                |                         |  |  |  |     |    |      |    |      |
|----------------------------|----------------|-------------------------|--|--|--|-----|----|------|----|------|
| Rated resistance           | $R$            |                         |  |  |  | 25  |    | 22   |    | kΩ   |
| Deviation of $R_{100}$     | $\Delta R/R$   | $R_{100} = 1486 \Omega$ |  |  |  | 100 | -5 |      | +5 | %    |
| Power dissipation          | $P$            |                         |  |  |  | 25  |    | 210  |    | mW   |
| Power dissipation constant |                |                         |  |  |  | 25  |    | 4,4  |    | mW/K |
| B-value                    | $B_{(25/50)}$  | Tol. -13,1%             |  |  |  | 25  |    | 3940 |    | K    |
| B-value                    | $B_{(25/100)}$ | Tol. +11,6%             |  |  |  | 25  |    | 4000 |    | K    |
| Vincotech NTC Reference    |                |                         |  |  |  |     |    |      | A  |      |

## Output Inverter

**figure 1**  
**Typical output characteristics**

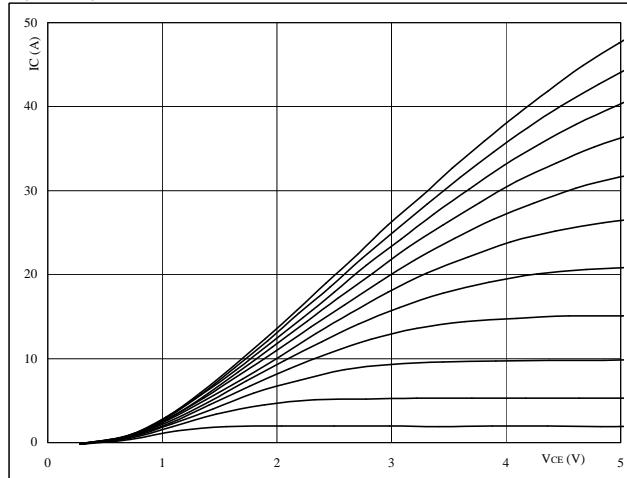
$$I_C = f(V_{CE})$$



$t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 2**  
**Typical output characteristics**

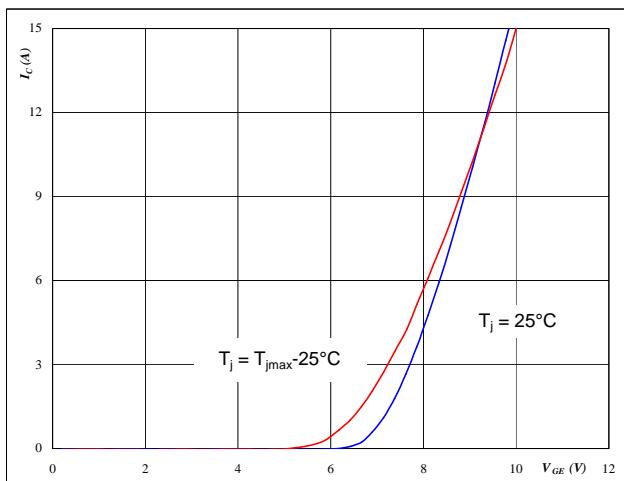
$$I_C = f(V_{CE})$$



$t_p = 250 \mu s$   
 $T_j = 150^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3**  
**Typical transfer characteristics**

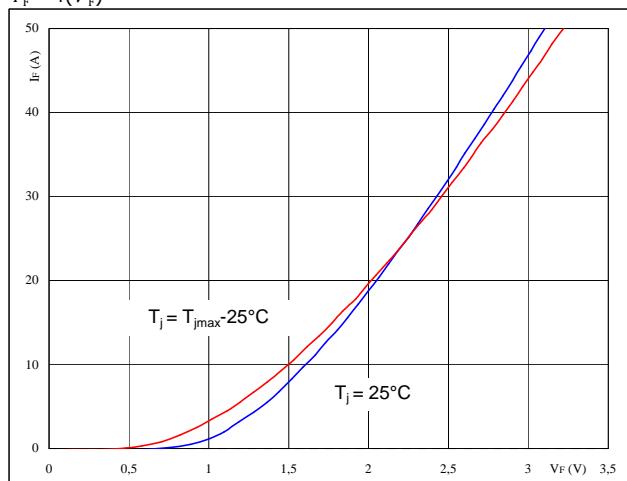
$$I_C = f(V_{GE})$$



$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**figure 4**  
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

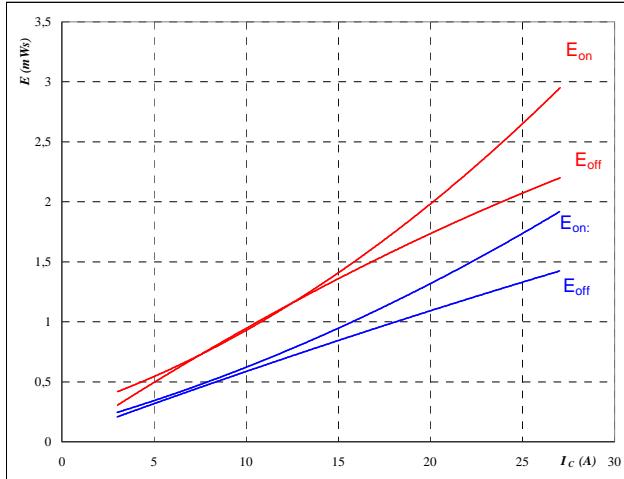
## Output Inverter

**figure 5**

IGBT

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_c)$$



inductive load

$$T_j = 25/150 \quad ^\circ C$$

$$V_{CE} = 600 \quad V$$

$$V_{GE} = \pm 15 \quad V$$

$$R_{gon} = 32 \quad \Omega$$

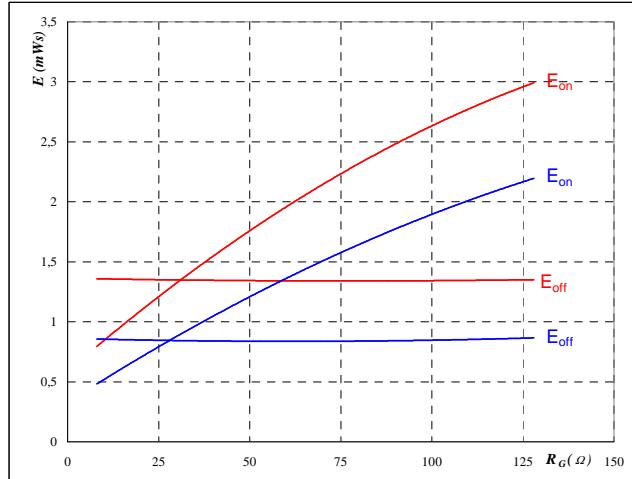
$$R_{goff} = 32 \quad \Omega$$

**figure 6**

IGBT

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



inductive load

$$T_j = 25/150 \quad ^\circ C$$

$$V_{CE} = 600 \quad V$$

$$V_{GE} = \pm 15 \quad V$$

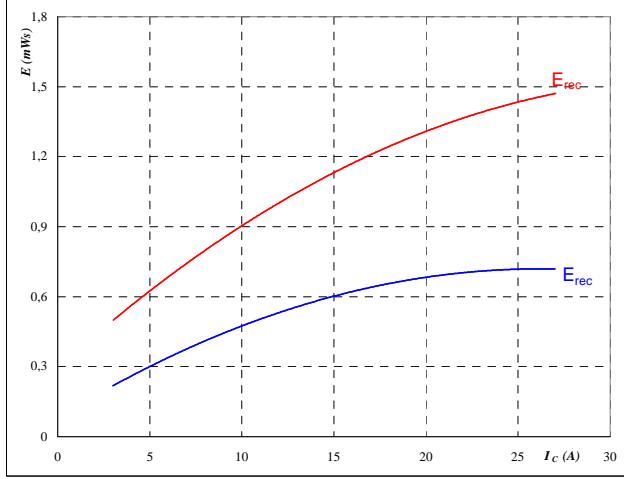
$$I_c = 15 \quad A$$

**figure 7**

IGBT

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_c)$$



inductive load

$$T_j = 25/150 \quad ^\circ C$$

$$V_{CE} = 600 \quad V$$

$$V_{GE} = \pm 15 \quad V$$

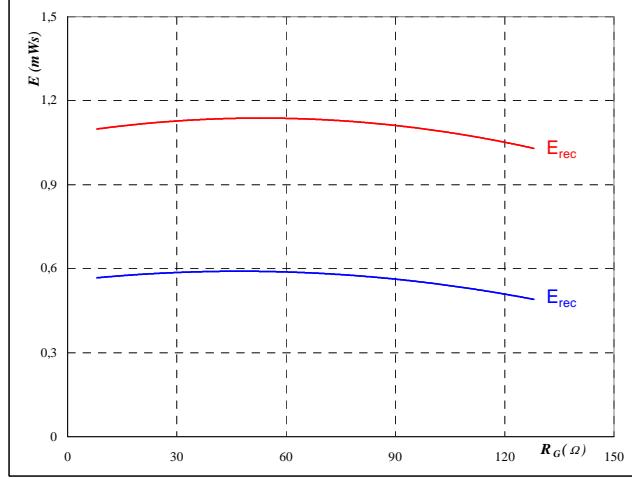
$$R_{gon} = 32 \quad \Omega$$

**figure 8**

IGBT

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



inductive load

$$T_j = 25/150 \quad ^\circ C$$

$$V_{CE} = 600 \quad V$$

$$V_{GE} = \pm 15 \quad V$$

$$I_c = 15 \quad A$$

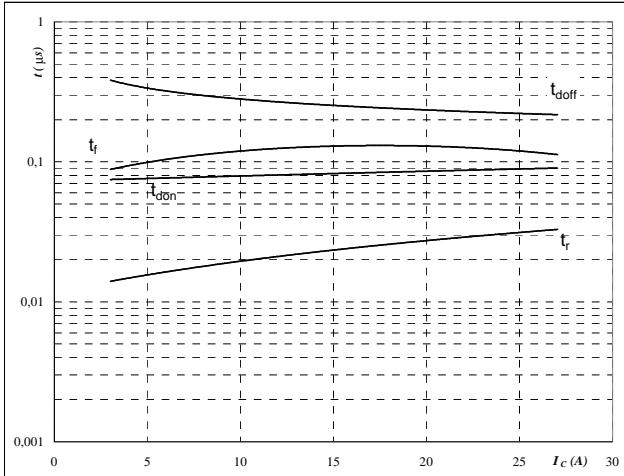
## Output Inverter

**figure 9**

IGBT

**Typical switching times as a function of collector current**

$$t = f(I_c)$$



inductive load

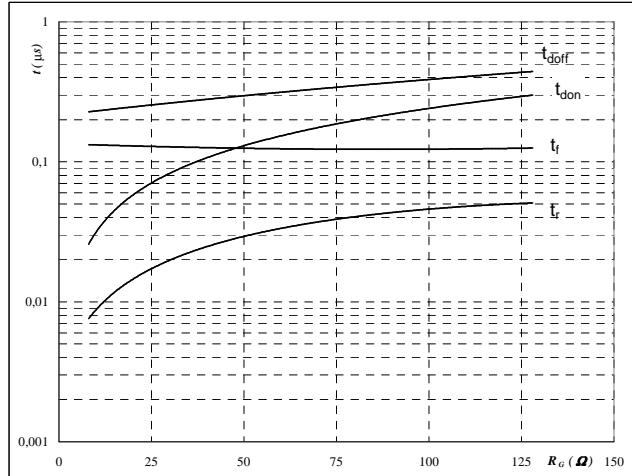
T<sub>j</sub> = 150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 R<sub>gon</sub> = 32 Ω  
 R<sub>goff</sub> = 32 Ω

**figure 10**

IGBT

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



inductive load

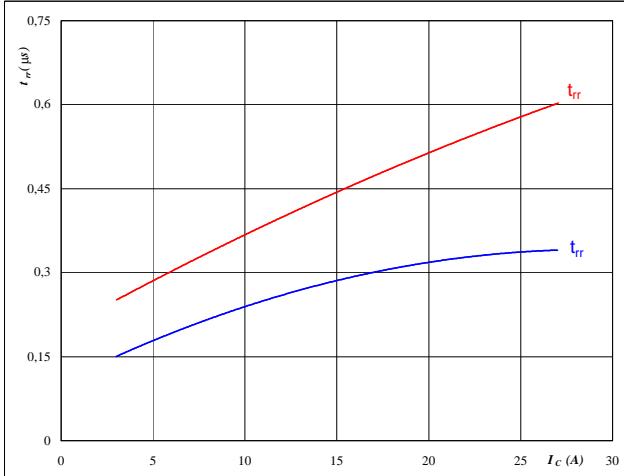
T<sub>j</sub> = 150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 I<sub>c</sub> = 15 A

**figure 11**

FWD

**Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_c)$$



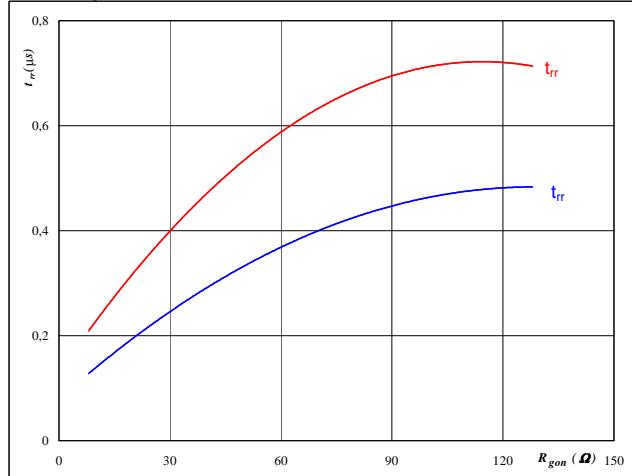
T<sub>j</sub> = 25/150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 R<sub>gon</sub> = 32 Ω

**figure 12**

FWD

**Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$



T<sub>j</sub> = 25/150 °C  
 V<sub>R</sub> = 600 V  
 I<sub>F</sub> = 15 A  
 V<sub>GE</sub> = ±15 V

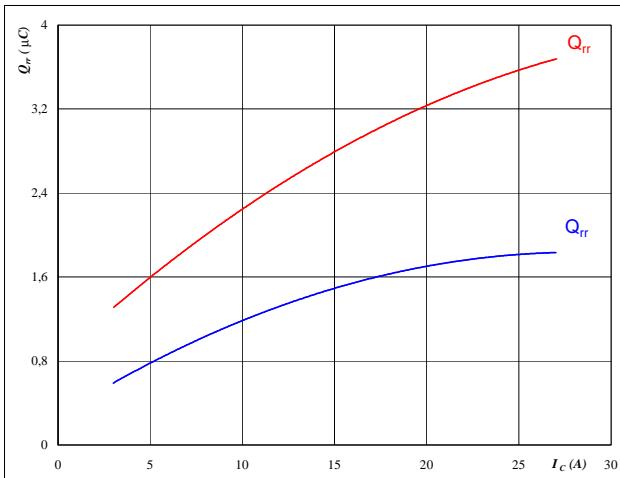
## Output Inverter

**figure 13**

FWD

**Typical reverse recovery charge as a function of collector current**

$$Q_{rr} = f(I_c)$$



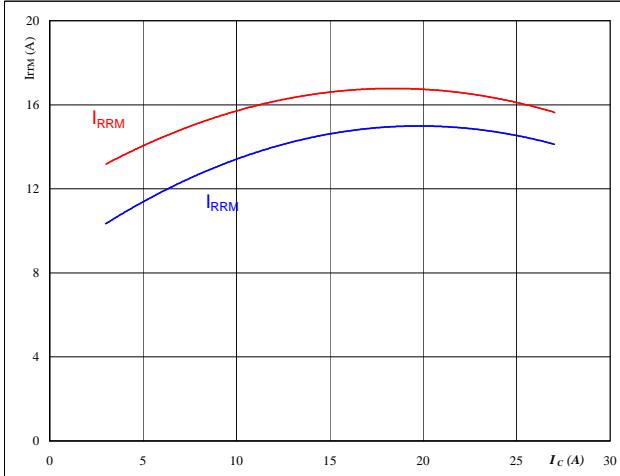
$T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 32 \Omega$

**figure 15**

FWD

**Typical reverse recovery current as a function of collector current**

$$I_{RRM} = f(I_c)$$



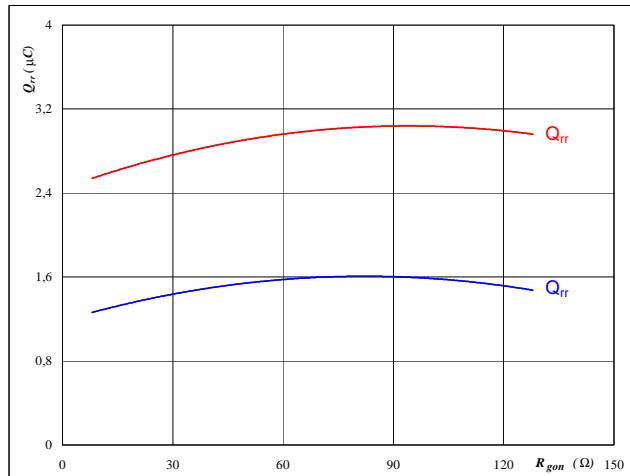
$T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 32 \Omega$

**figure 14**

FWD

**Typical reverse recovery charge as a function of IGBT turn on gate resistor**

$$Q_{rr} = f(R_{gon})$$



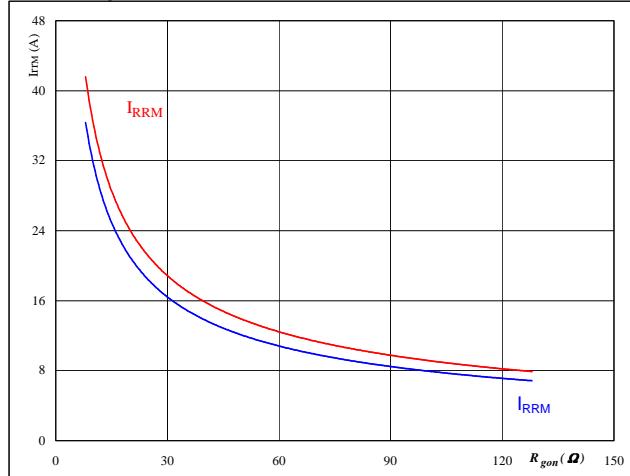
$T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_R = 600 \text{ V}$   
 $I_F = 15 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

**figure 16**

FWD

**Typical reverse recovery current as a function of IGBT turn on gate resistor**

$$I_{RRM} = f(R_{gon})$$



$T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_R = 600 \text{ V}$   
 $I_F = 15 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$



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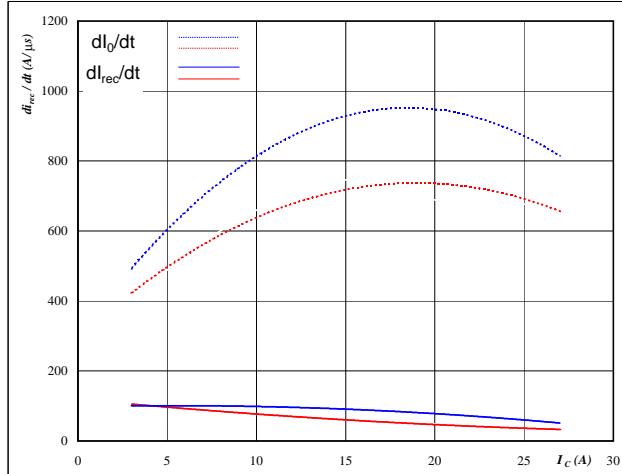
datasheet

## Output Inverter

**figure 17**

FWD

**Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current**  
 $dI_0/dt, dI_{rec}/dt = f(I_c)$

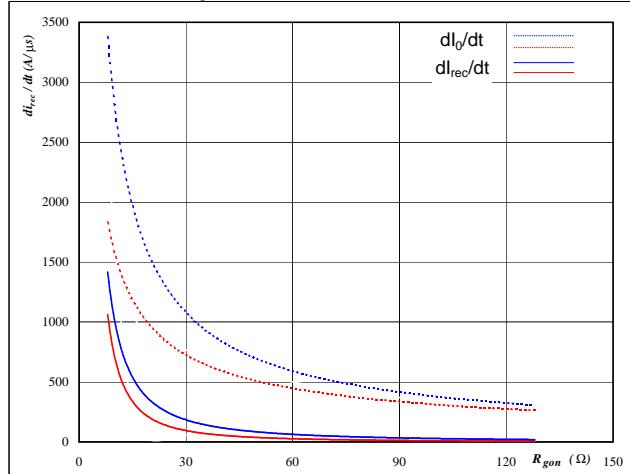


T<sub>j</sub> = 25/150 °C  
V<sub>CE</sub> = 600 V  
V<sub>GE</sub> = ±15 V  
R<sub>gon</sub> = 32 Ω

**figure 18**

FWD

**Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor**  
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$



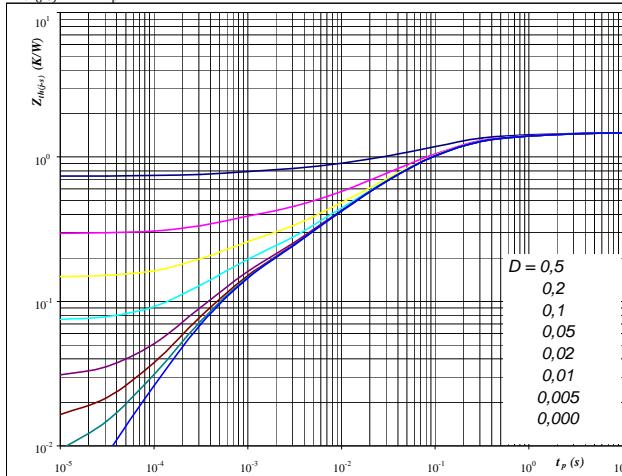
T<sub>j</sub> = 25/150 °C  
V<sub>R</sub> = 600 V  
I<sub>F</sub> = 15 A  
V<sub>GE</sub> = ±15 V

**figure 19**

IGBT

**IGBT transient thermal impedance  
as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



D = t<sub>p</sub> / T

R<sub>th(j-s)</sub> = 1,47 K/W

IGBT thermal model values

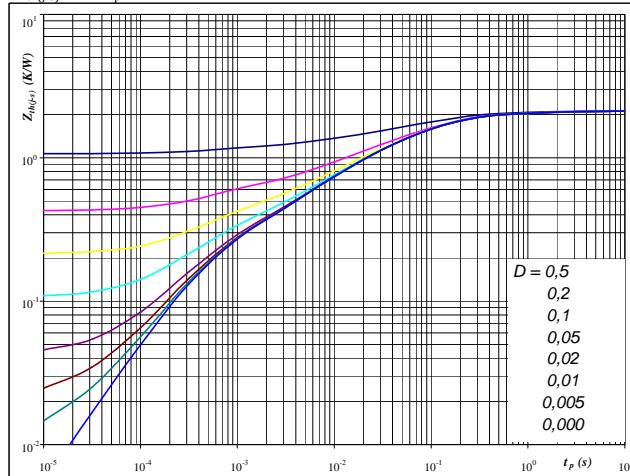
| R (K/W)  | Tau (s)  |
|----------|----------|
| 3,36E-02 | 6,20E+00 |
| 1,49E-01 | 8,76E-01 |
| 6,48E-01 | 1,22E-01 |
| 3,84E-01 | 2,46E-02 |
| 1,52E-01 | 4,46E-03 |
| 1,05E-01 | 4,60E-04 |

**figure 20**

FWD

**FWD transient thermal impedance  
as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



D = t<sub>p</sub> / T

R<sub>th(j-s)</sub> = 2,13 K/W

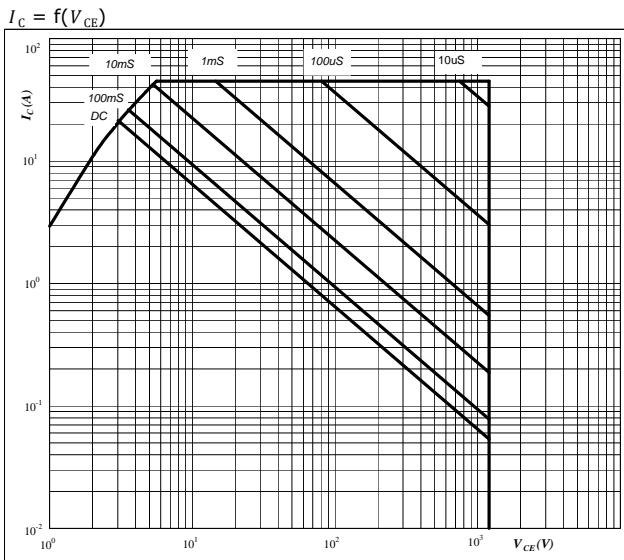
FWD thermal model values

| R (K/W)  | Tau (s)  |
|----------|----------|
| 4,24E-02 | 8,88E+00 |
| 1,67E-01 | 8,86E-01 |
| 8,12E-01 | 1,17E-01 |
| 6,39E-01 | 2,38E-02 |
| 2,77E-01 | 3,91E-03 |
| 1,96E-01 | 4,44E-04 |

## Output Inverter

**figure 21**

IGBT

**Safe operating area as a function  
of collector-emitter voltage**

 $D =$  single pulse

 $T_s =$  80 °C

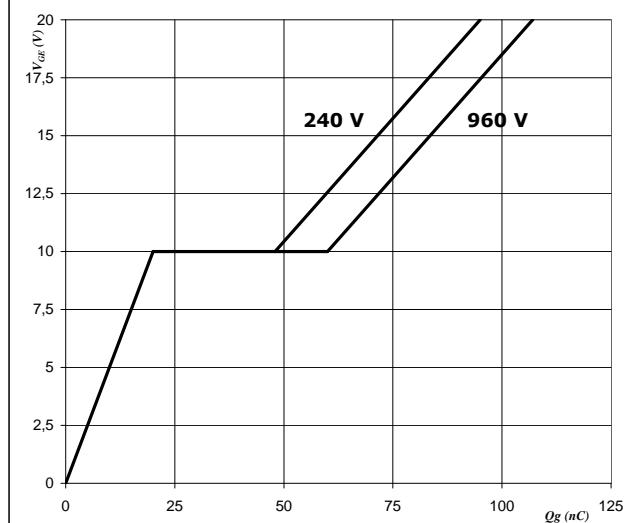
 $V_{GE} = \pm 15$  V

 $T_j = T_{jmax}$ 
**figure 22**

IGBT

**Gate voltage vs Gate charge**

$V_{GE} = f(Q_g)$


 $I_C = 15$  A

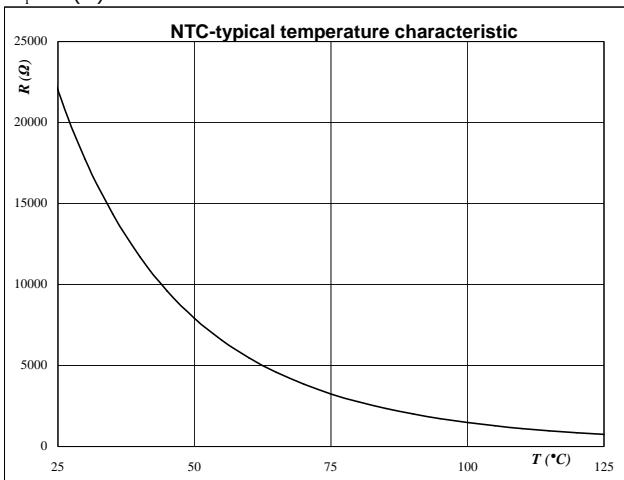
## Thermistor

**figure 1**

Thermistor

**Typical NTC characteristic**
**as a function of temperature**

$R_T = f(T)$



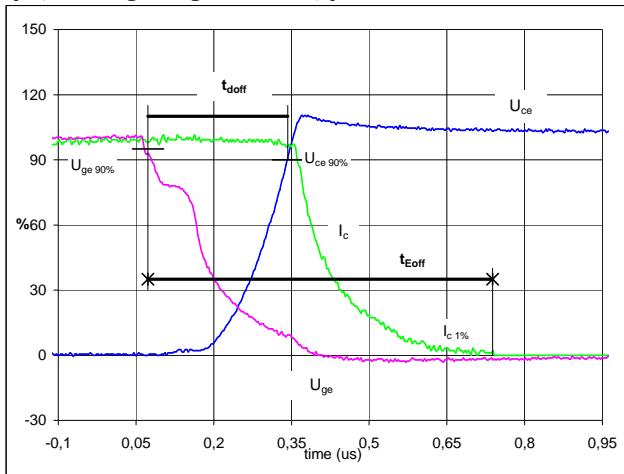
## Switching Definitions Output Inverter

**General conditions**

|            |          |
|------------|----------|
| $T_j$      | = 150 °C |
| $R_{gon}$  | = 32 Ω   |
| $R_{goff}$ | = 32 Ω   |

**Figure 1** IGBT

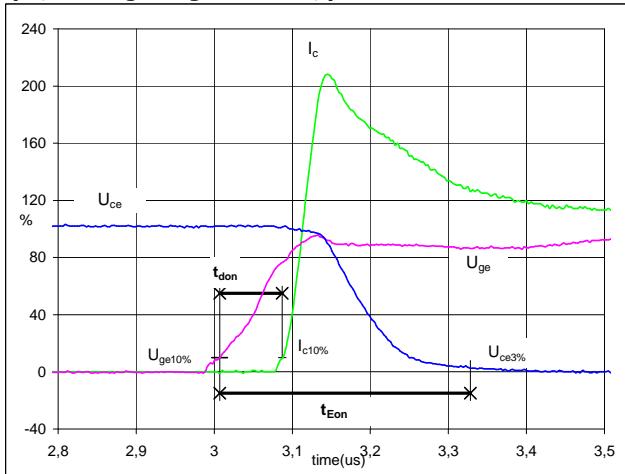
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
 $(t_{Eoff} = \text{integrating time for } E_{off})$



$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 600$  V  
 $I_C\ (100\%) = 15$  A  
 $t_{doff} = 0,26$  μs  
 $t_{Eoff} = 0,67$  μs

**Figure 2** IGBT

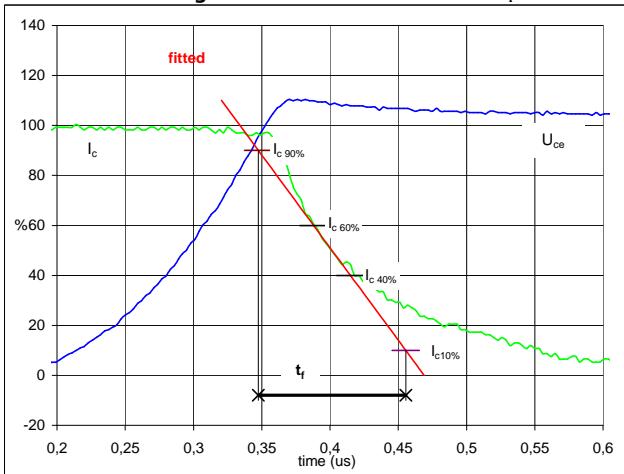
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
 $(t_{Eon} = \text{integrating time for } E_{on})$



$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 600$  V  
 $I_C\ (100\%) = 15$  A  
 $t_{don} = 0,08$  μs  
 $t_{Eon} = 0,32$  μs

**Figure 3** IGBT

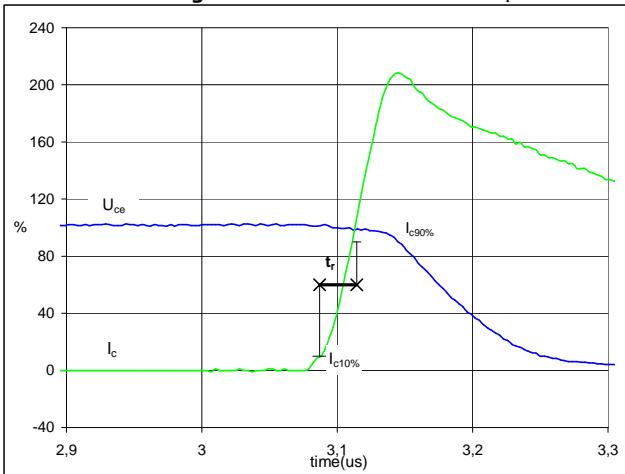
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C\ (100\%) = 600$  V  
 $I_C\ (100\%) = 15$  A  
 $t_f = 0,13$  μs

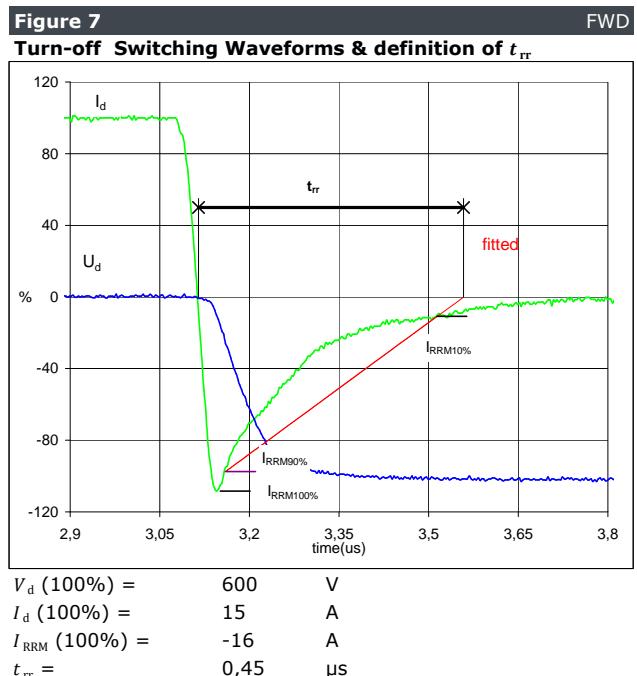
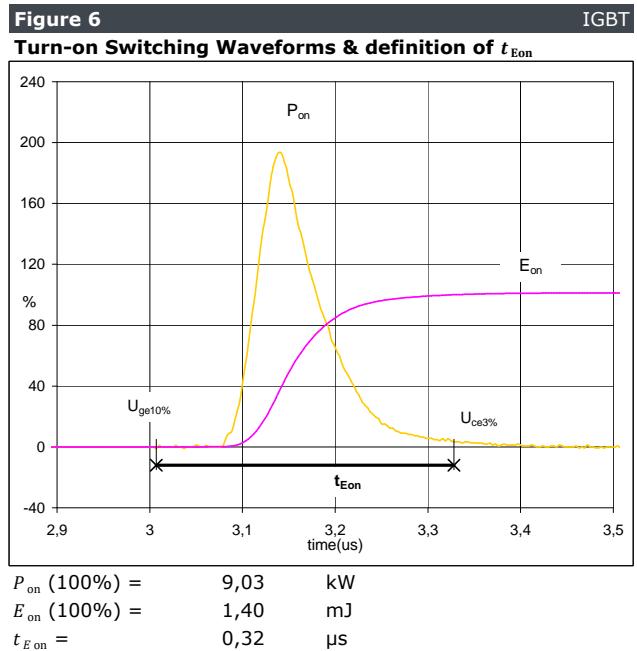
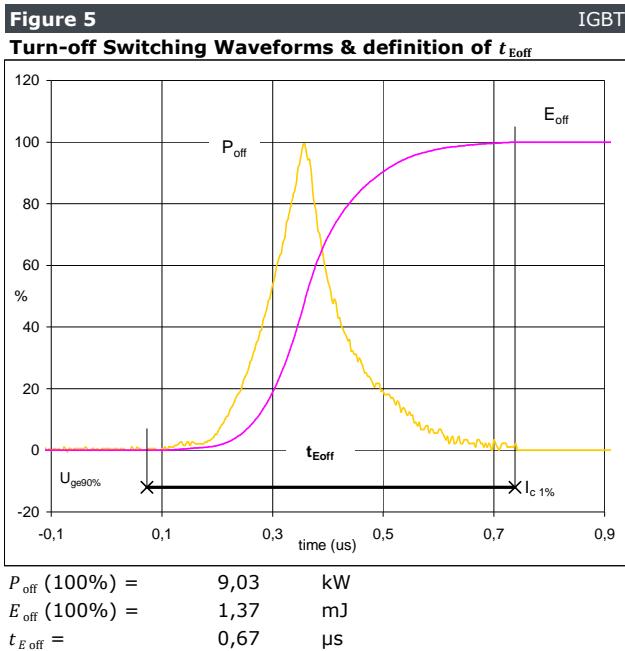
**Figure 4** IGBT

**Turn-on Switching Waveforms & definition of  $t_r$**

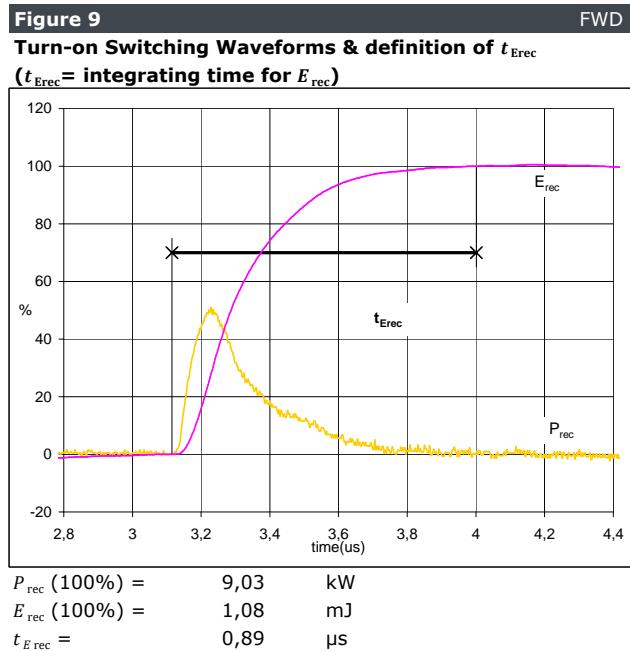
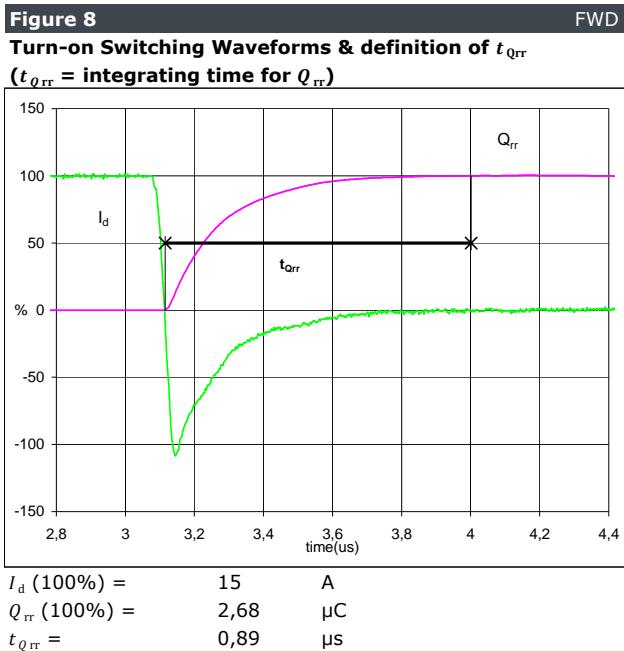


$V_C\ (100\%) = 600$  V  
 $I_C\ (100\%) = 15$  A  
 $t_r = 0,02$  μs

## Switching Definitions Output Inverter



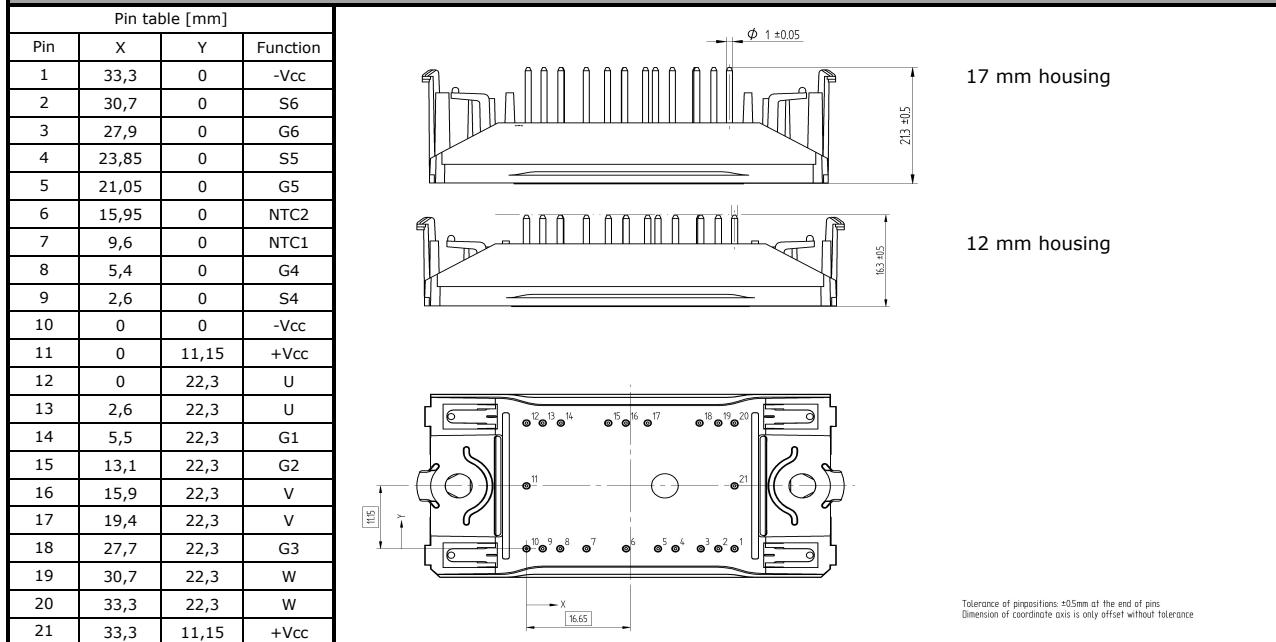
## Switching Definitions Output Inverter



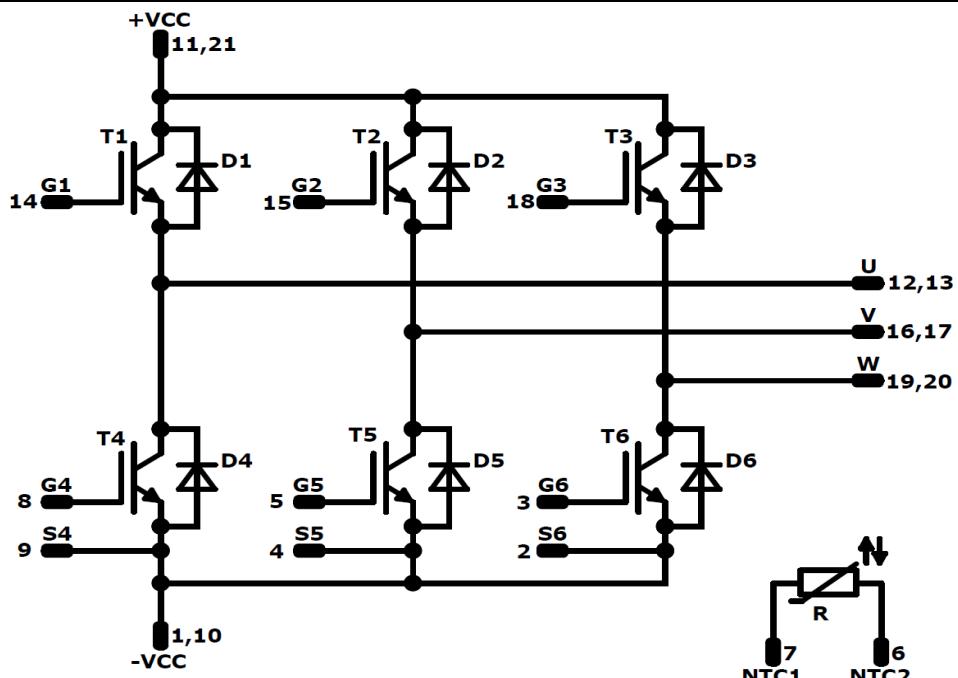
### Ordering Code & Marking

| Version                              |  |  | Ordering Code      |          |            |          |           |      |
|--------------------------------------|--|--|--------------------|----------|------------|----------|-----------|------|
| without thermal paste 17 mm housing  |  |  | V23990-P868-F49-PM |          |            |          |           |      |
| without thermal paste 12 mm housing  |  |  | V23990-P868-F48-PM |          |            |          |           |      |
| VIN WWYY<br>NNNNNNVV UL<br>LLLL SSSS |  |  | Text               | VIN      | Date code  | Name&Ver | UL        | Lot  |
|                                      |  |  |                    | VIN      | WWYY       | NNNNNNVV | UL        | LLLL |
|                                      |  |  | Datamatrix         | Type&Ver | Lot number | Serial   | Date code | SSSS |
|                                      |  |  |                    | TTTTTTVV | LLLLL      | SSSS     | WWYY      |      |

### Outline



### Pinout



### Identification

| ID                     | Component | Voltage | Current | Function            | Comment |
|------------------------|-----------|---------|---------|---------------------|---------|
| T1, T2, T3, T4, T5, T6 | IGBT      | 1200 V  | 15 A    | Inverter Transistor |         |
| D1, D2, D3, D4, D5, D6 | FWD       | 1200 V  | 15 A    | Inverter Diode      |         |
| R                      | NTC       |         |         | Thermistor          |         |



Vincotech

V23990-P868-F49-PM

V23990-P868-F48-PM

datasheet

**Packaging instruction**

|                                   |     |      |          |      |        |
|-----------------------------------|-----|------|----------|------|--------|
| Standard packaging quantity (SPQ) | 135 | >SPQ | Standard | <SPQ | Sample |
|-----------------------------------|-----|------|----------|------|--------|

**Handling instruction**Handling instructions for *flow* 0 packages see vincotech.com website.**Package data**Package data for *flow* 0 packages see vincotech.com website.**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



| Document No.:         | Date:        | Modification: | Pages |
|-----------------------|--------------|---------------|-------|
| V23990-P868-F4x-D3-14 | 28 Jan. 2018 |               |       |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.